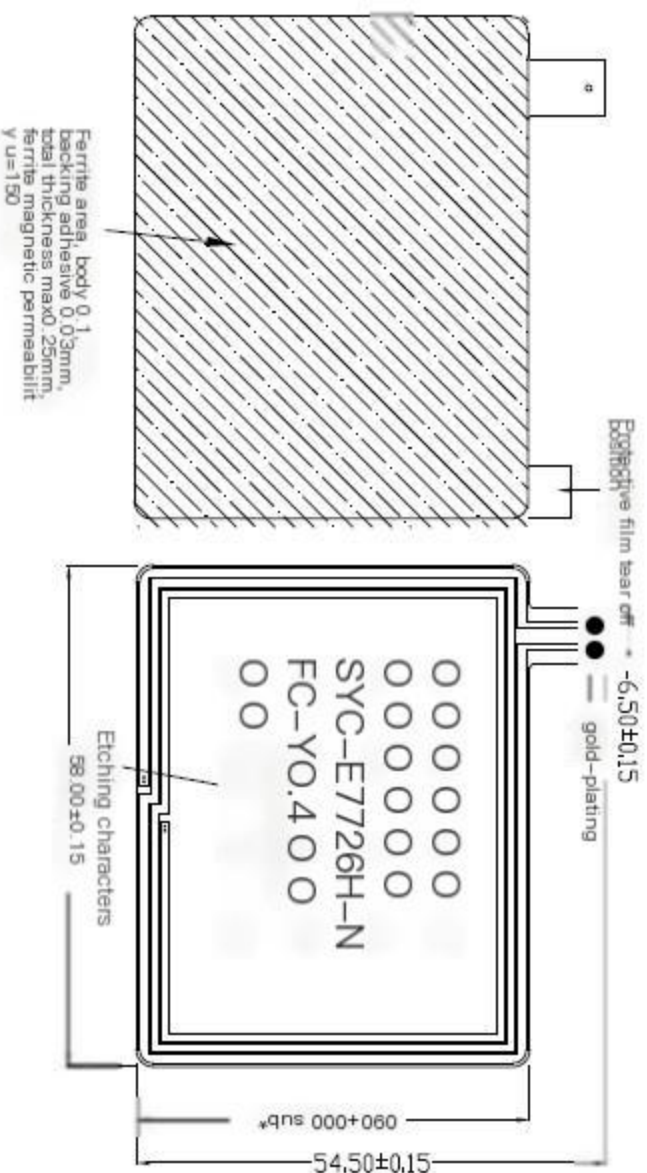
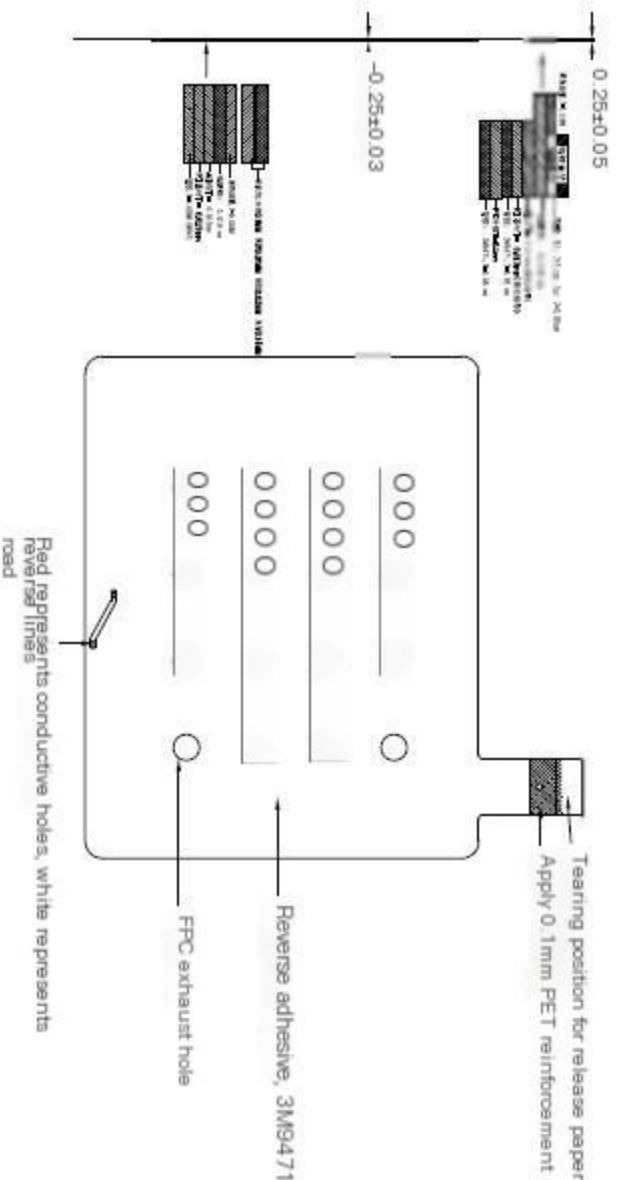


front

Back
adhesive
surfacetechnical
requirement

1. Shipping packaging requirements: (For micro mucosal shipments, leave test holes on the PAD)
2. Apply black matte ink on the surface of the copper pot.

3. The ink should be uniform;

4. Sizes marked with "*" are the key dimensions.

5. Use TESA68540+3M9471 for backing adhesive;

6. Use P1 T=0.5mm electrolytic copper as the substrate;

7. Copper foil thickness of 0.5oz;

8. The thickness of the gold plating yellow in the gold-plated area is ≥ 0.5 microns, and the salt spray test has been conducted for 48 hours.
9. The unmarked rounded corners are all 0.2, and the process edge is 0.2mm.

10. For unmarked tolerances, follow the general tolerance table;

11. The product complies with RoHS requirements.

12. Range of inductance values: $\sim \mu\text{H}$

Gold plated area



Line area

Adhesive
backing
areaShanghai Shangyuan Communication Technology
Co., Ltd

PART NAME: E7726H NFC		DATE: 2024.12.31	
PART NO: SH242031B99		DRAWN: Zhang Yuanfeng	
RF:		Tel:	
TOLERANCE X, X soil 0.25 XX 0.25, XX soil 0.05 ANGULAR ± 0.5		Tel:	
PM: Ma Ronglai		Tel:	
MATERIAL:		CHECKED: Yu Jiang	
FINISHING:		APPROVED:	
UNIT: mm		SCALE: 1:1	
COLOUR: black		REV: LS04	